

3D Micro-Electro-Mechanical Systems (MEMS) Process Simulation Using CSuprem

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Outlines

- Introduction
- MEMS applications
- 3D MEMS simulation with CSuprem
- 3D MEMS process simulation results
 - Radio Frequency (RF) Switches
 - Electrometer MEMS
 - Polysilicon MEMS
 - SOI MEMS
 - MEMS-Tunable VCSELs

Introduction

- MEMS fabrication requires accurate simulation of geometry and material behavior
- Process simulation and analysis of MEMS is a challenge
- Structures are geometrically more complicated than those in IC electronic devices
- Structures are electro-mechanically coupled
- Multi-domain physics (optical, electrical, mechanical, and microfluidics) is required
- Csuprem can be used as a “black-box” geometric/physic-based process simulator for 3d MEMS
- Csuprem accurately predicts all the processing steps and generates accurate geometry suitable for simulating 3d MEMS operations

MEMS applications

- Optics (actuators, scanning mirrors, switches,...)
- Automotive (airbag sensors, fuel sensors, force sensors, pressure sensors,)
- Biomedical sensors
- RF devices
- Ink jet printers
- Military (biochemical warfare detection, inertial systems for guidance and navigation)
- and more

3D MEMS simulation with CSuprem

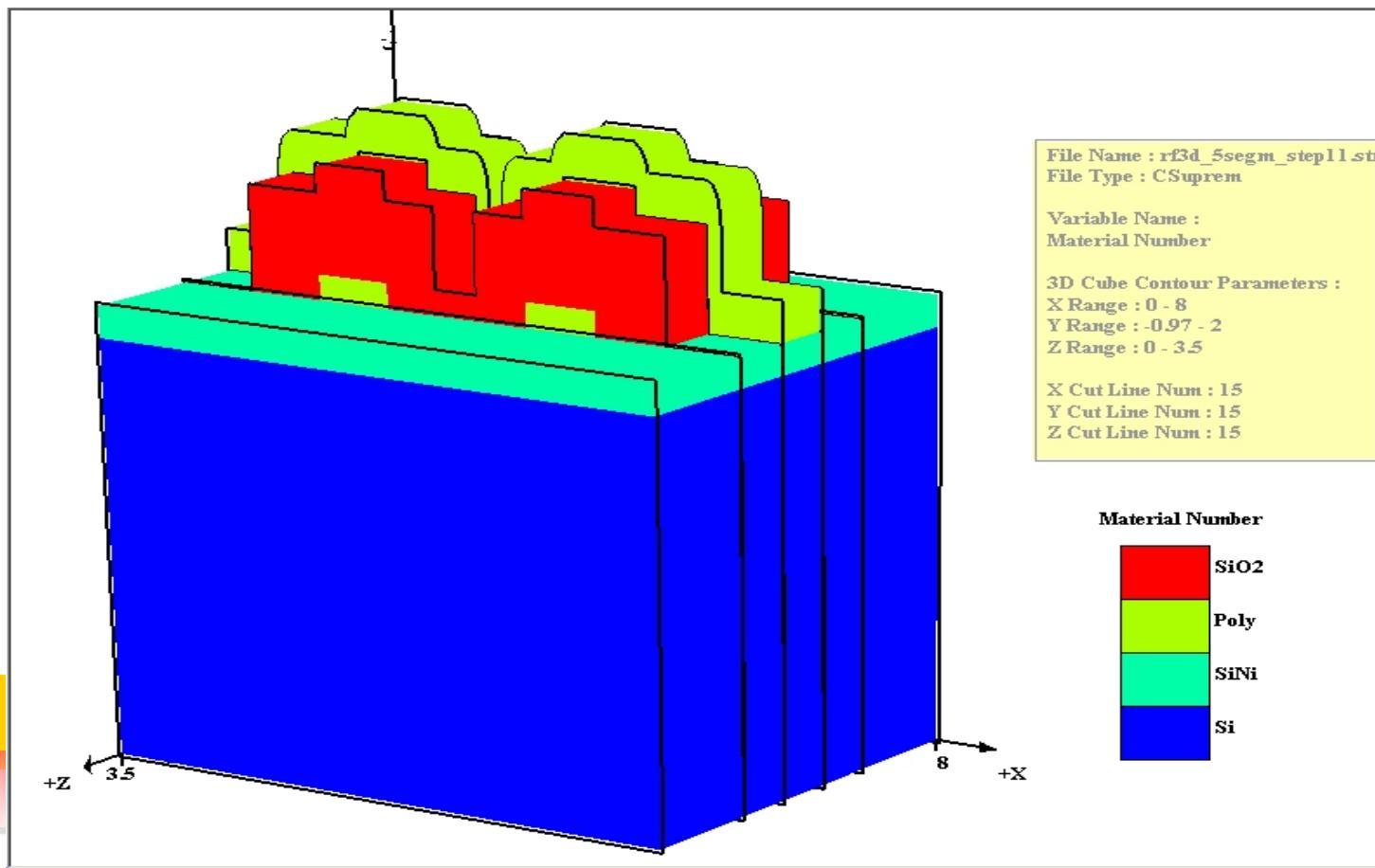
- Accurate selective Etching/Deposition
- Implantation,Oxidation, and Diffusion
- Accurate Delaunay mesh generation
- Domain decomposition-based new concept for 3d geometry modeling
- Size of 3d mesh is very reasonable (~3000 points only for RF switch)

3D MEMS simulation results

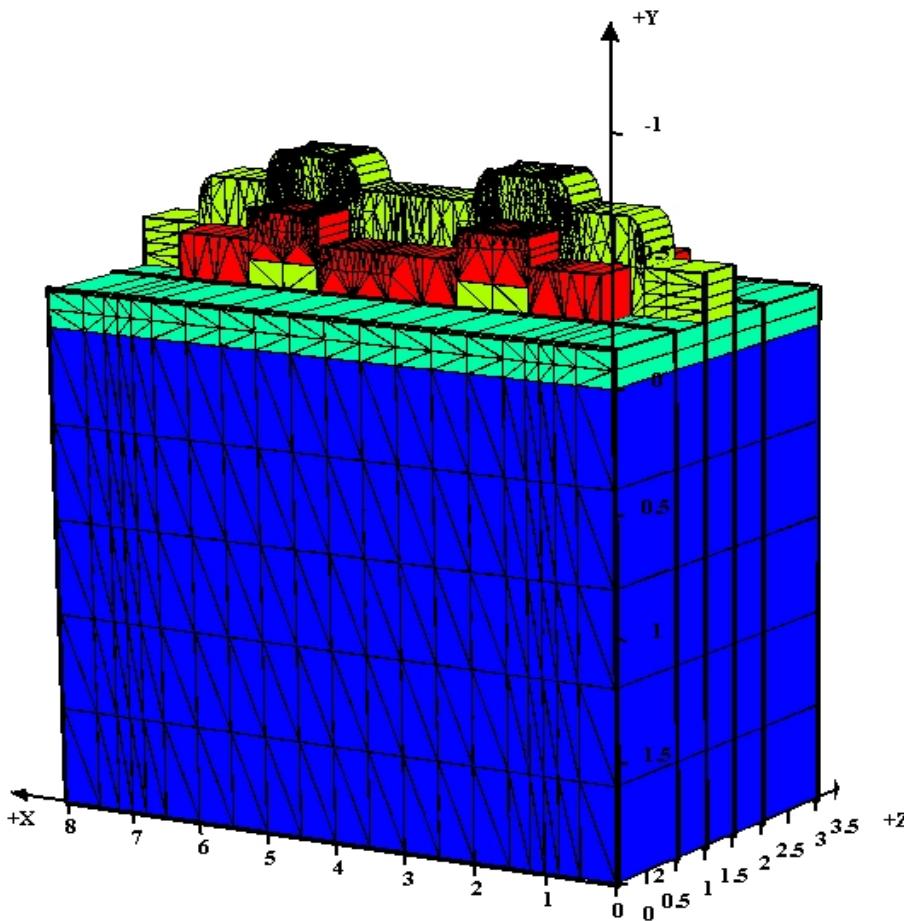
- RF Switches process simulation
- Electrometer process simulation
- Polysilicon MEMS process simulation
- SOI MEMS process simulation
- MT-VCSOA process simulation

I- RF Switch process simulation

Structure before release



3D Mesh with rounded corners



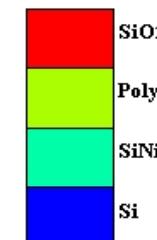
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File Type : CSuprem

Variable Name :
Material Number

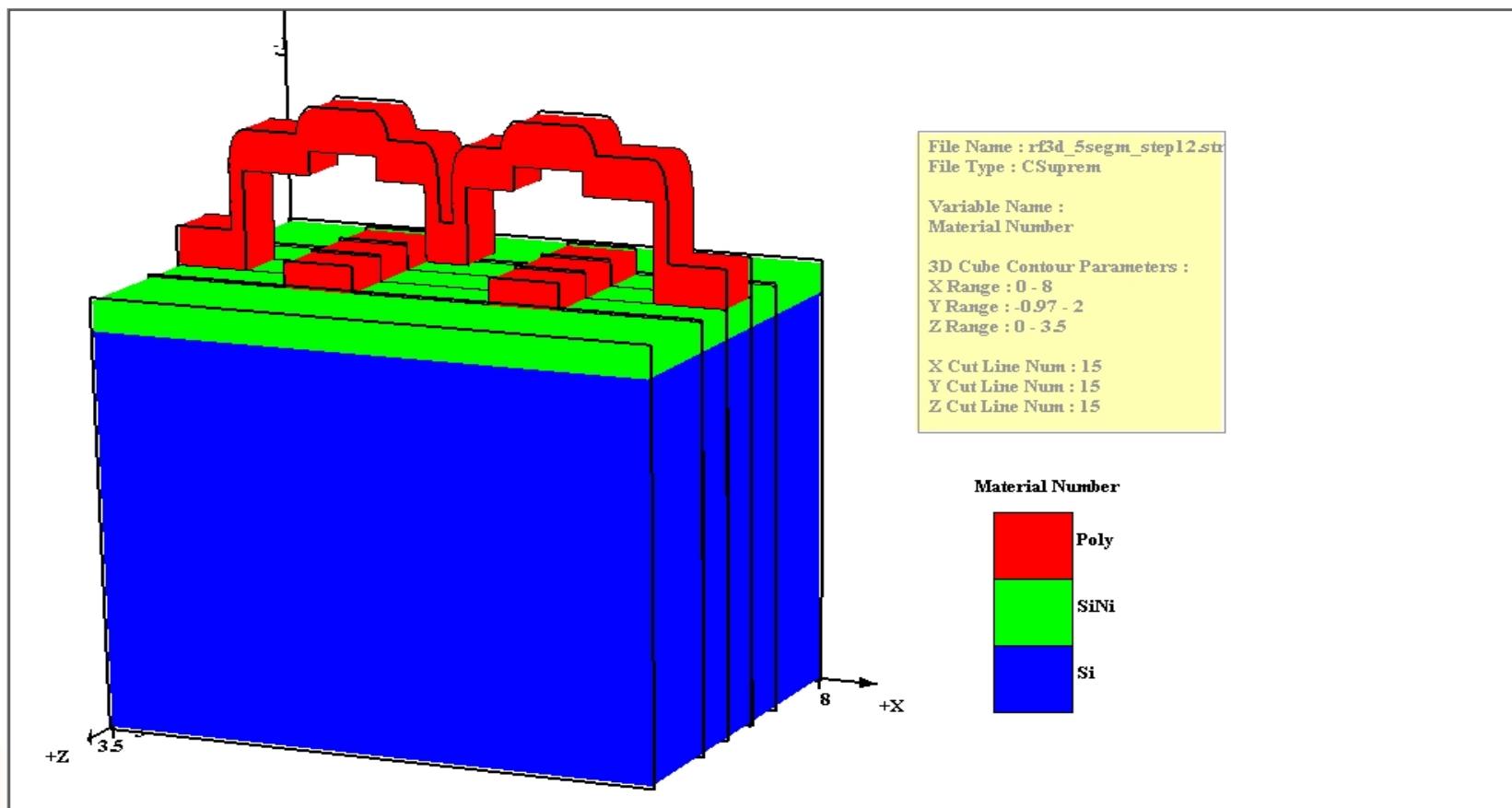
3D Cube Contour Parameters :
X Range : 0 - 8
Y Range : -0.67 - 2
Z Range : 0 - 3.5

X Cut Line Num : 15
Y Cut Line Num : 15
Z Cut Line Num : 15

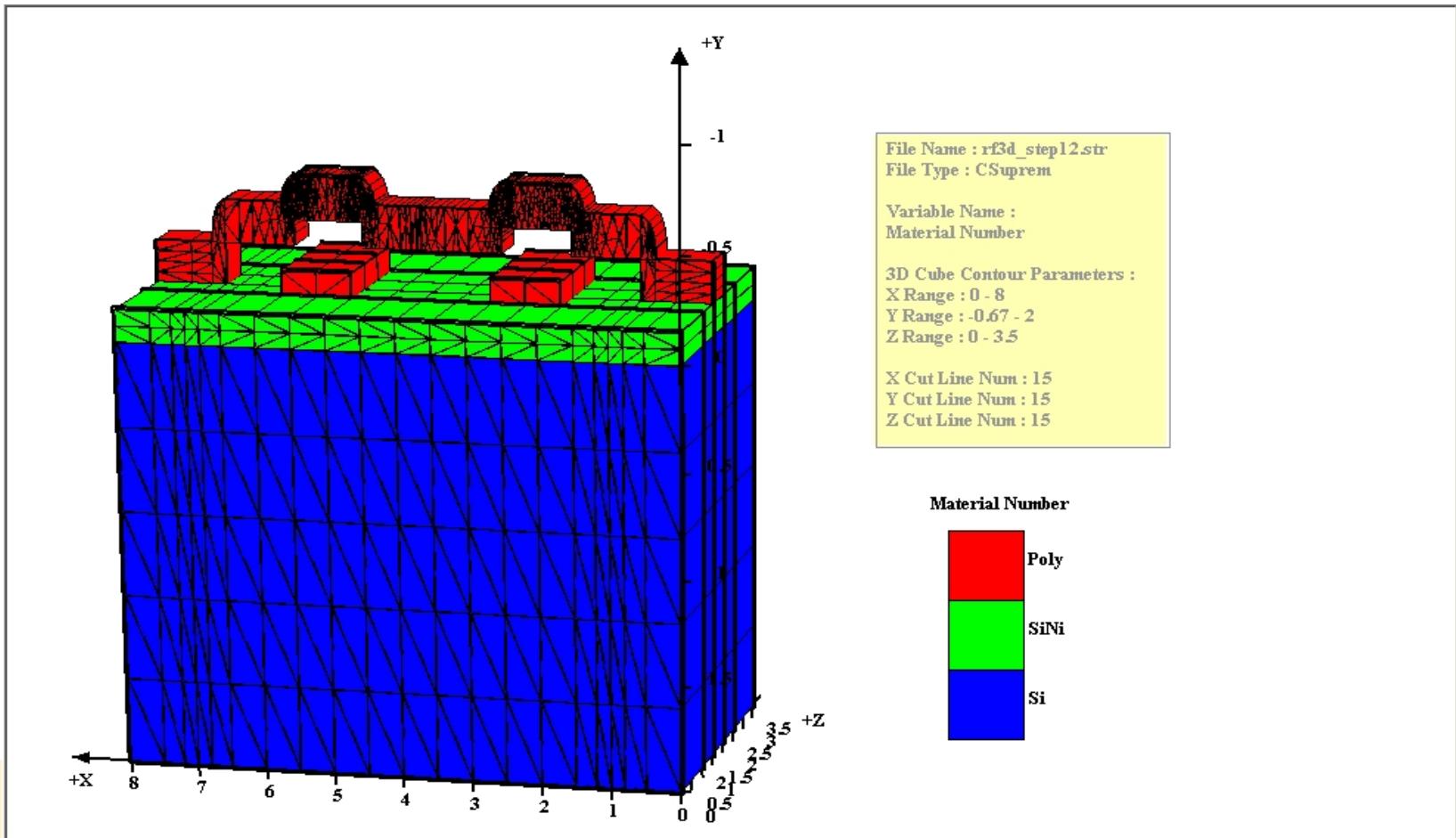
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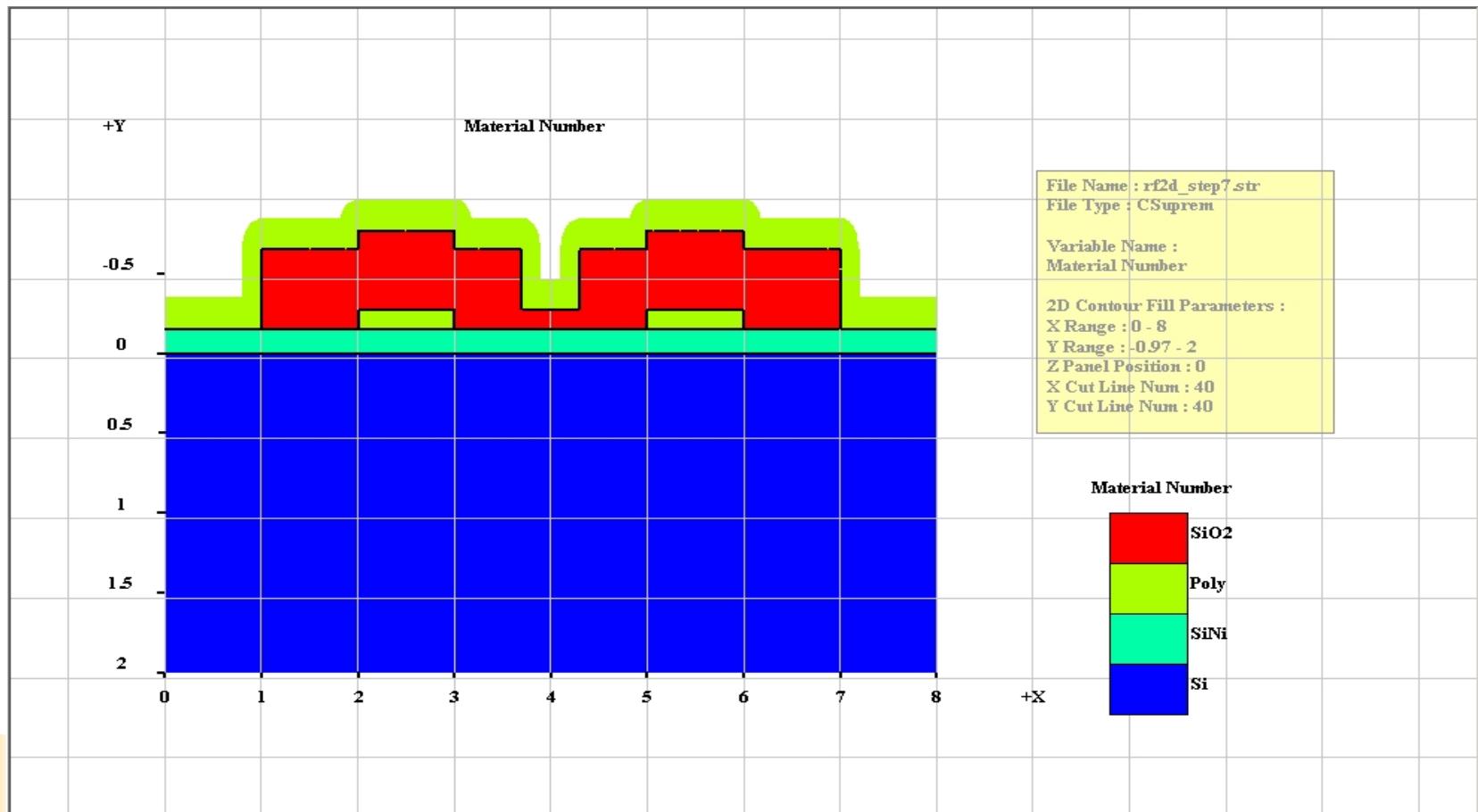
Structure after release



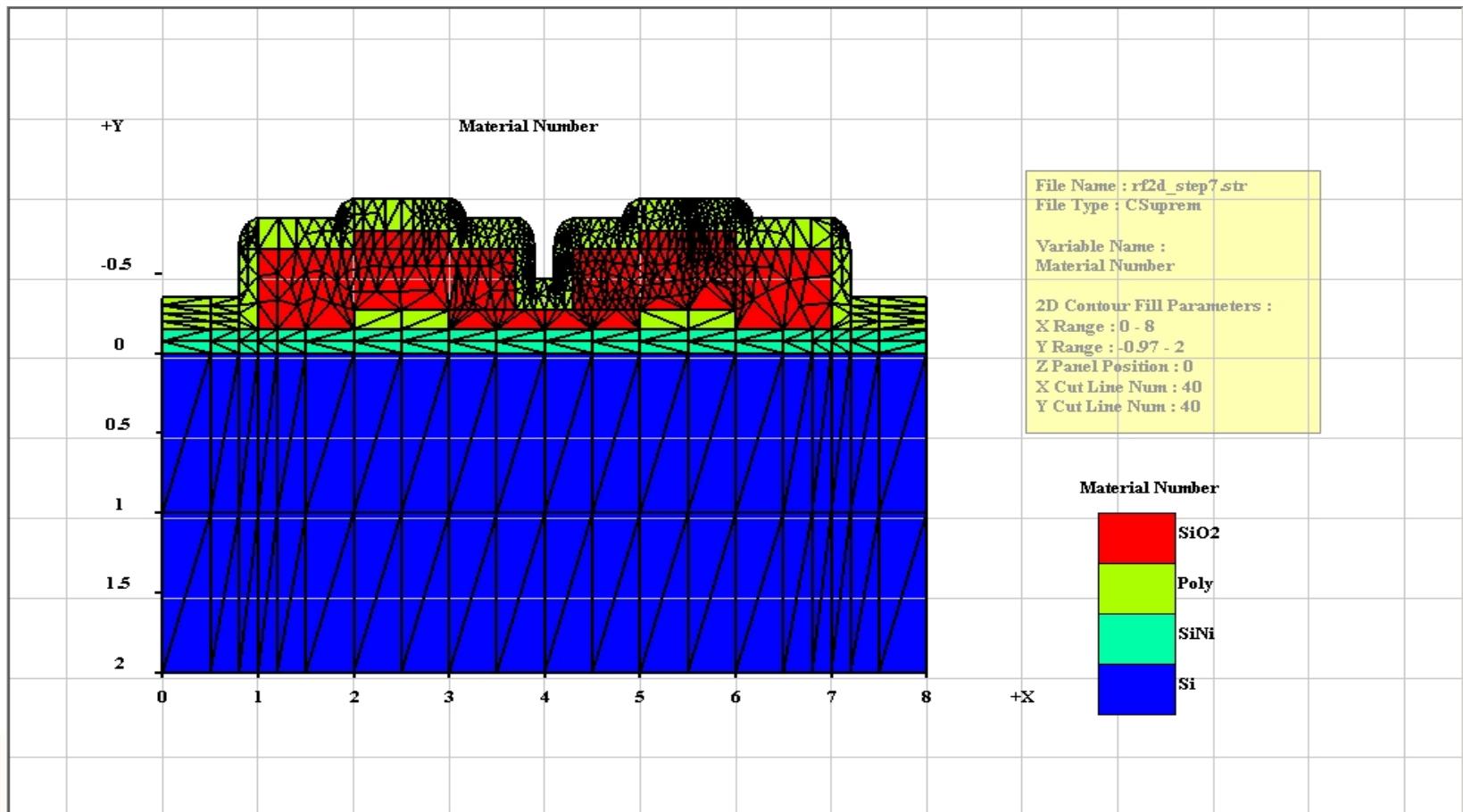
3D Mesh after release



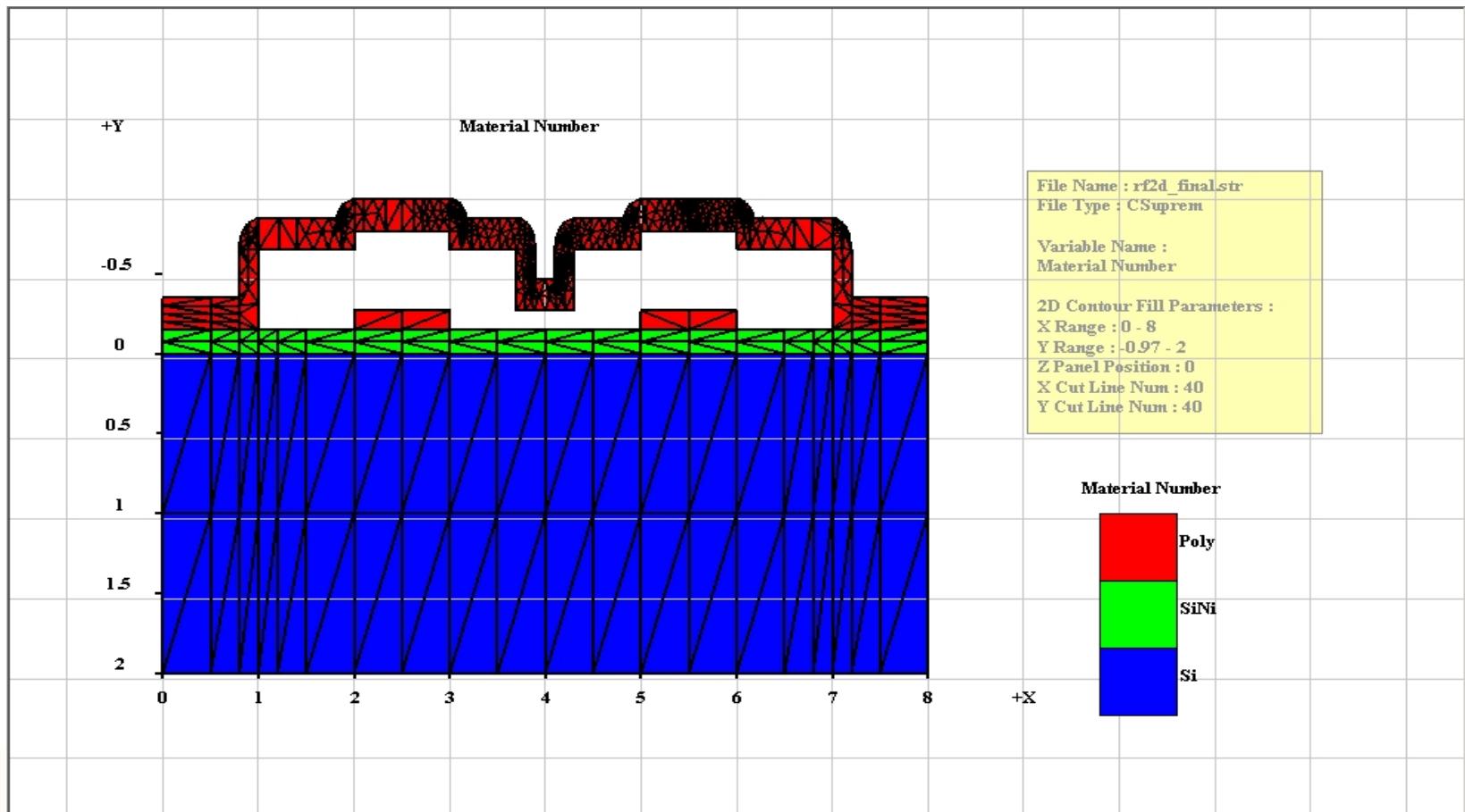
RF switch cross-section



Cross-section's mesh before release

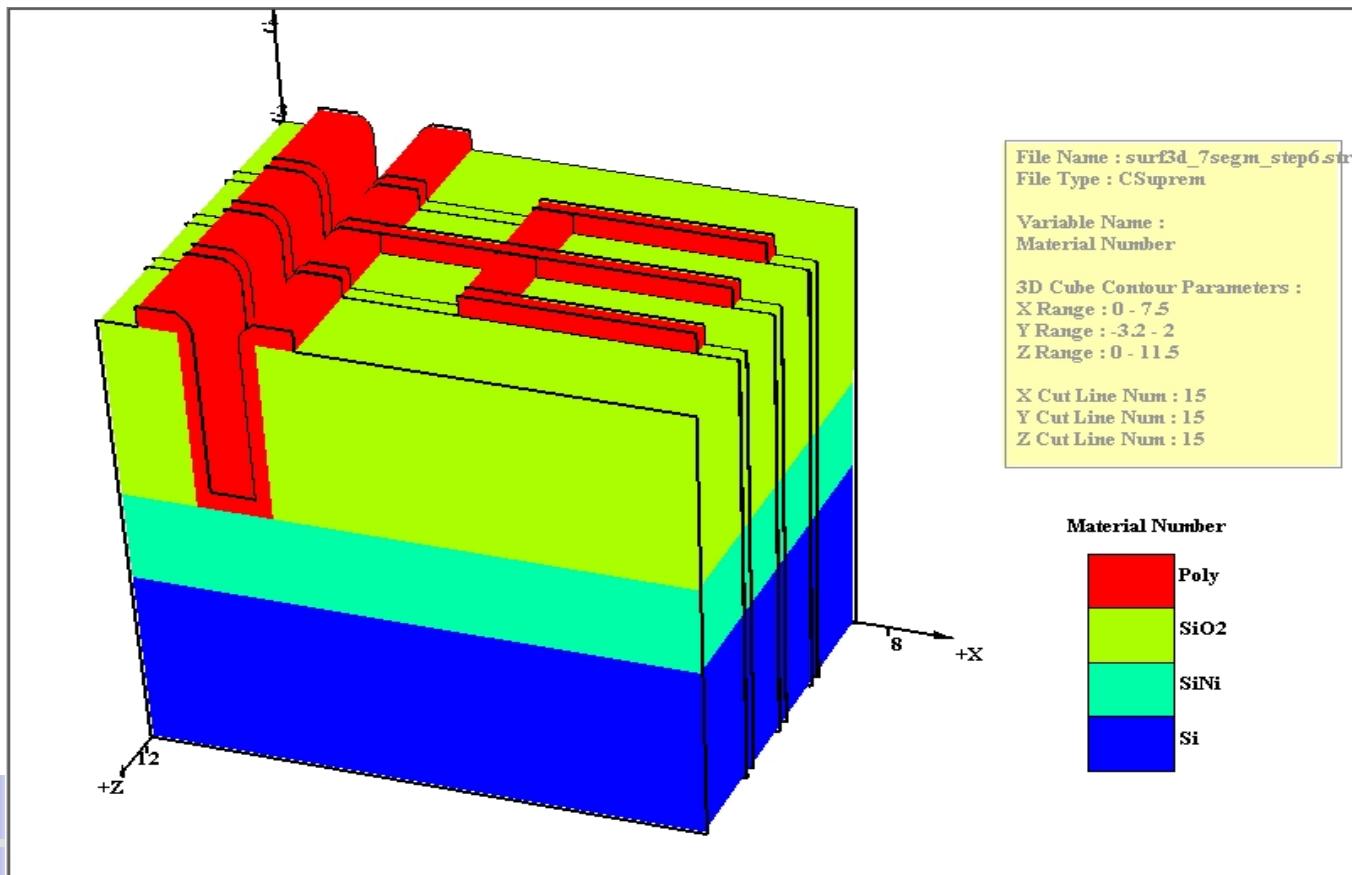


Cross-section's mesh after release

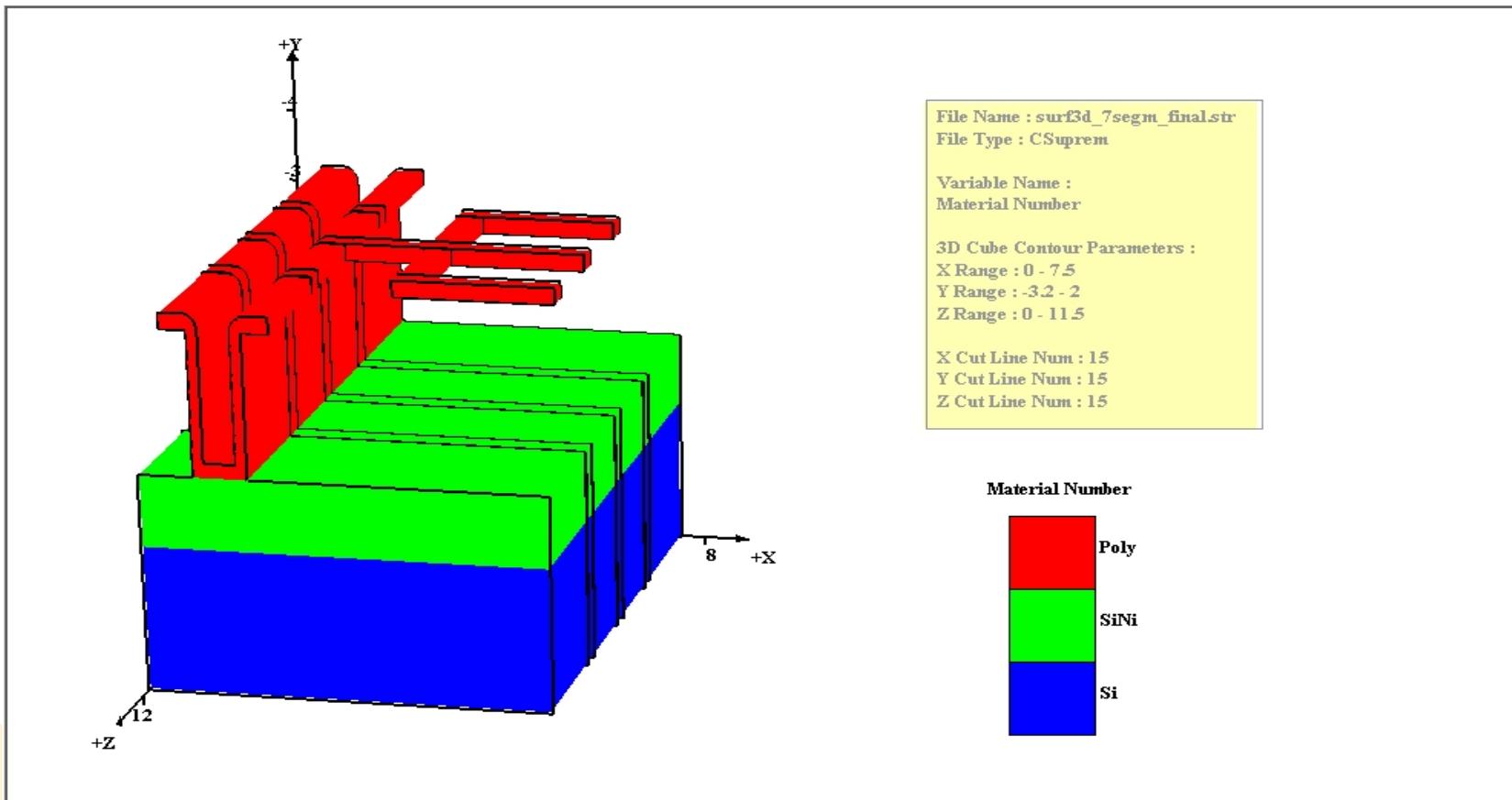


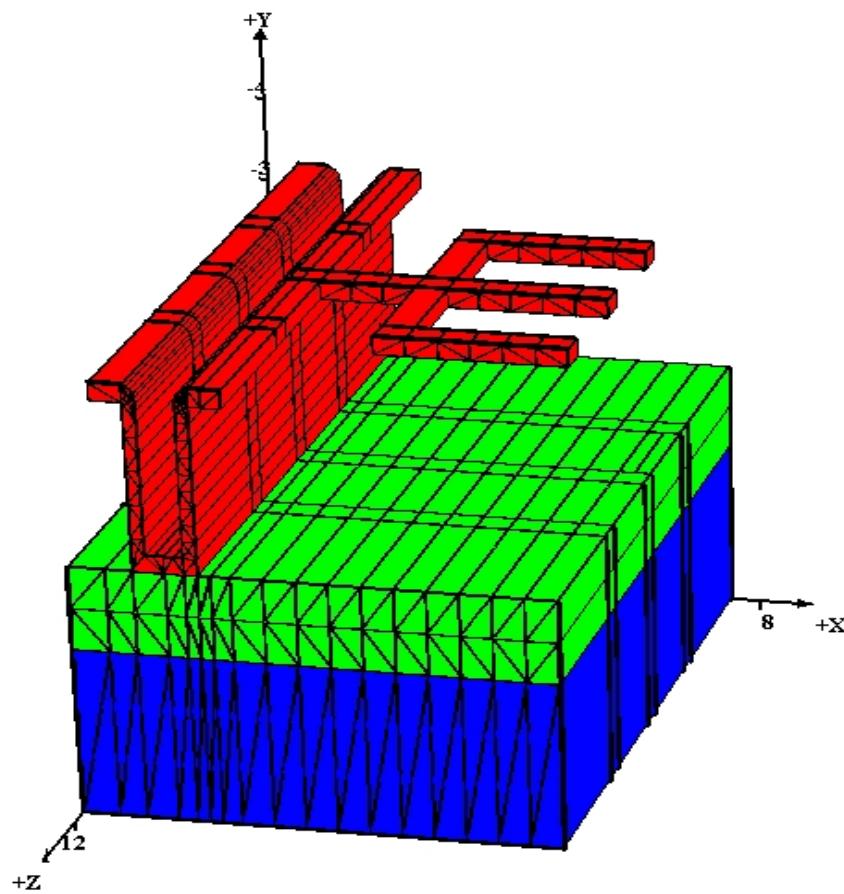
II- Electrometer process simulation

Structure before release



Structure after release





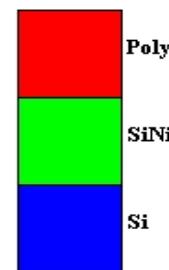
File Name : meter3d_final.str
File Type : CSuprem

Variable Name :
Material Number

3D Cube Contour Parameters :
X Range : 0 - 7.5
Y Range : -3.2 - 2
Z Range : 0 - 11.5

X Cut Line Num : 15
Y Cut Line Num : 15
Z Cut Line Num : 15

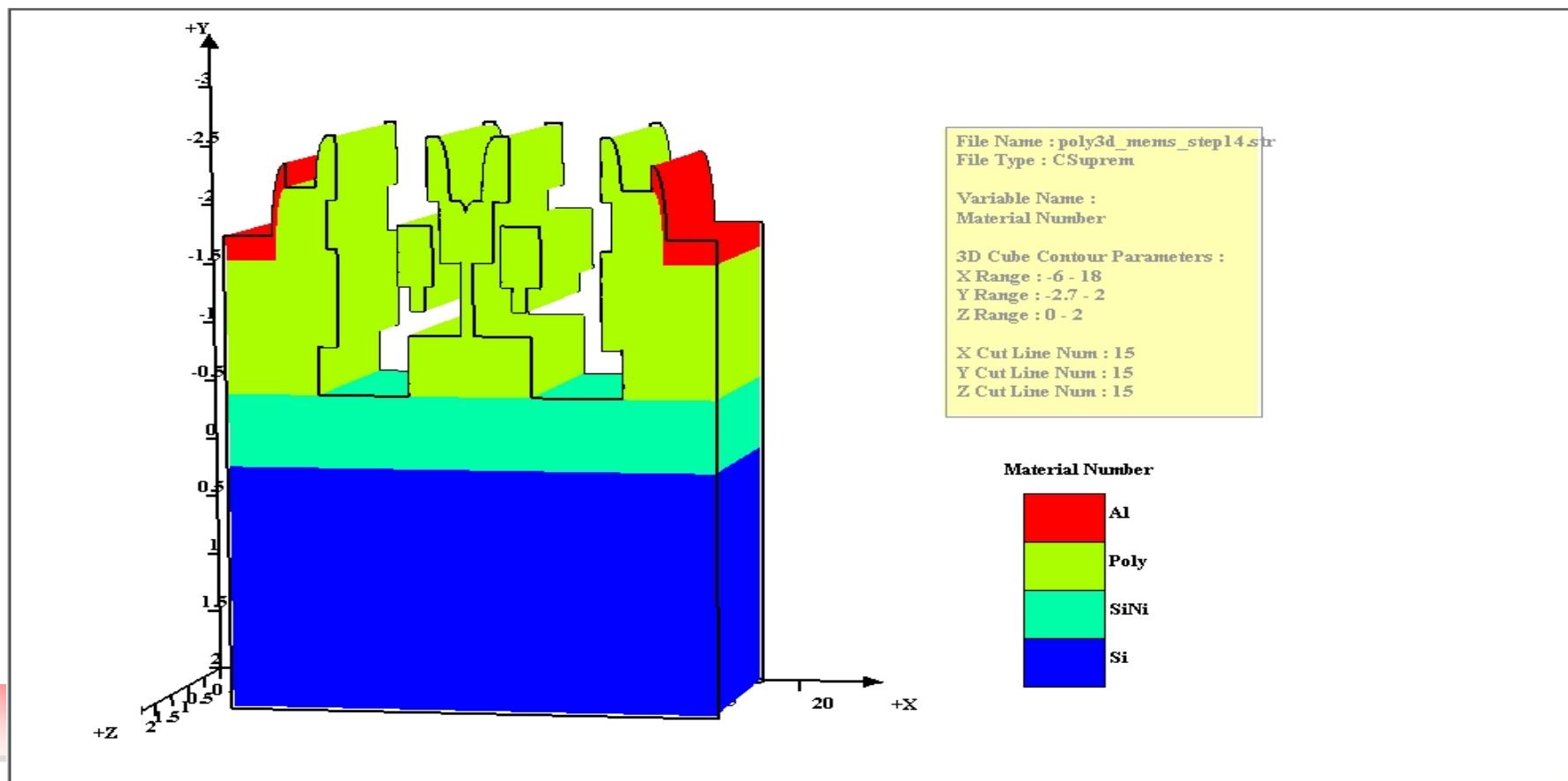
Material Number



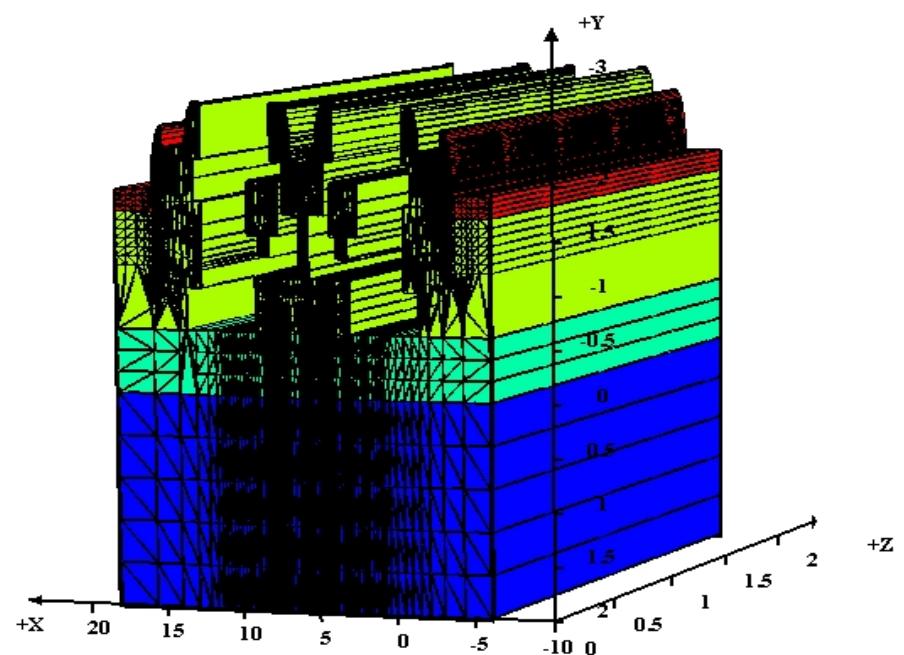
3D Mesh after release

III- PolyMEMS process simulation

3d structure after release



3D Mesh after release



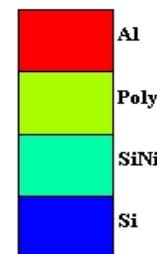
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File Type : CSuprem

Variable Name :
Material Number

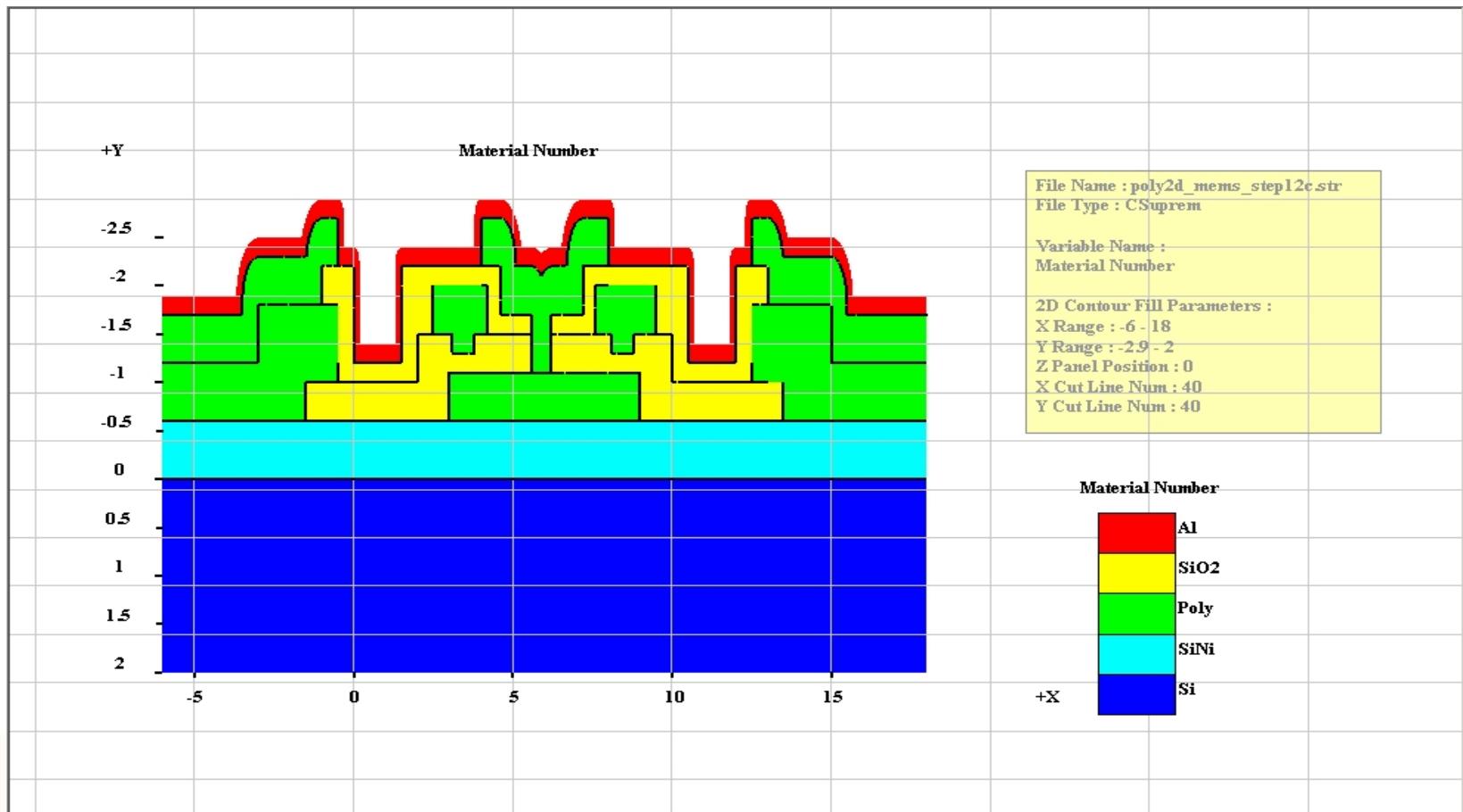
3D Cube Contour Parameters :
X Range : -6 - 18
Y Range : -2.7 - 2
Z Range : 0 - 2

X Cut Line Num : 15
Y Cut Line Num : 15
Z Cut Line Num : 15

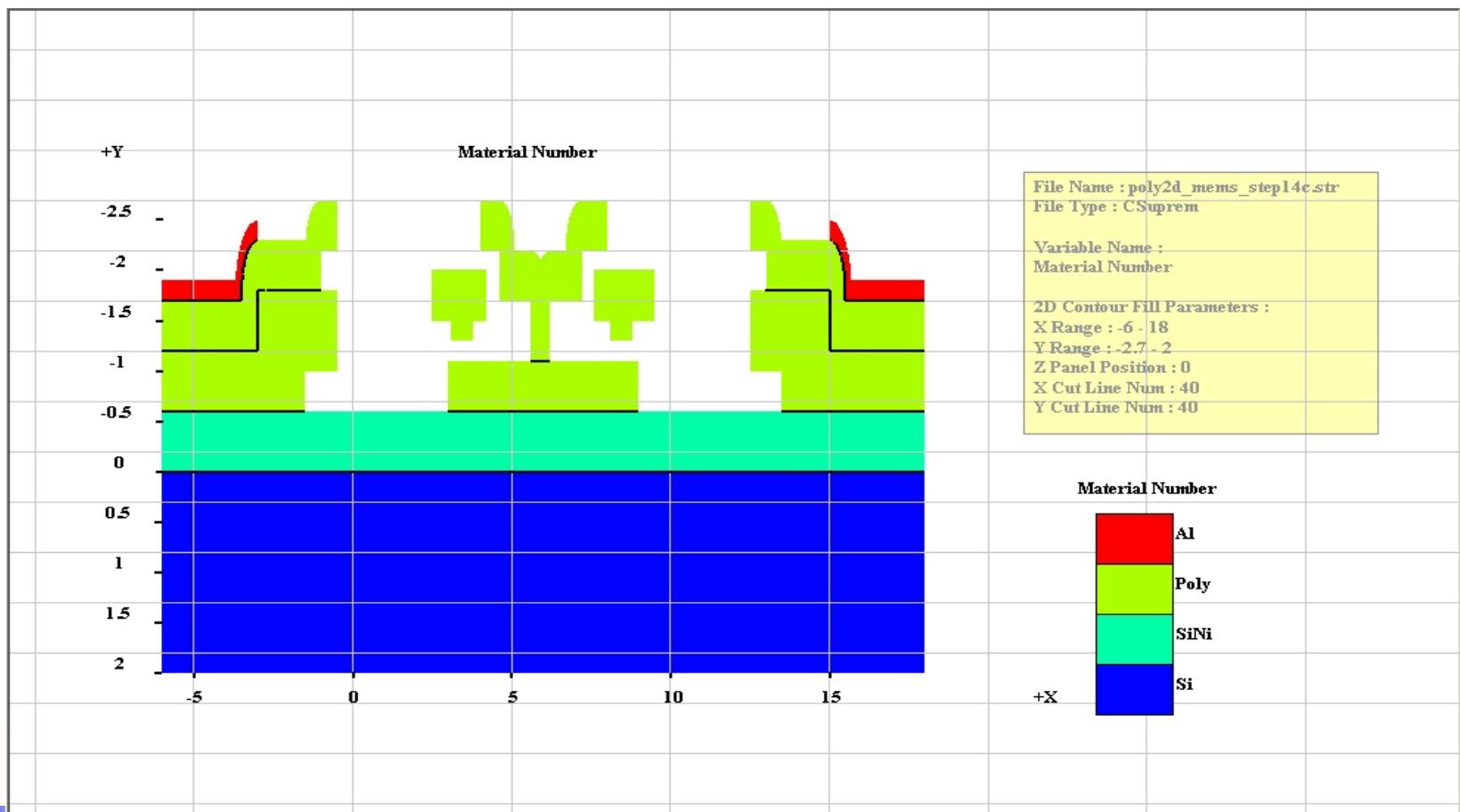
Material Number



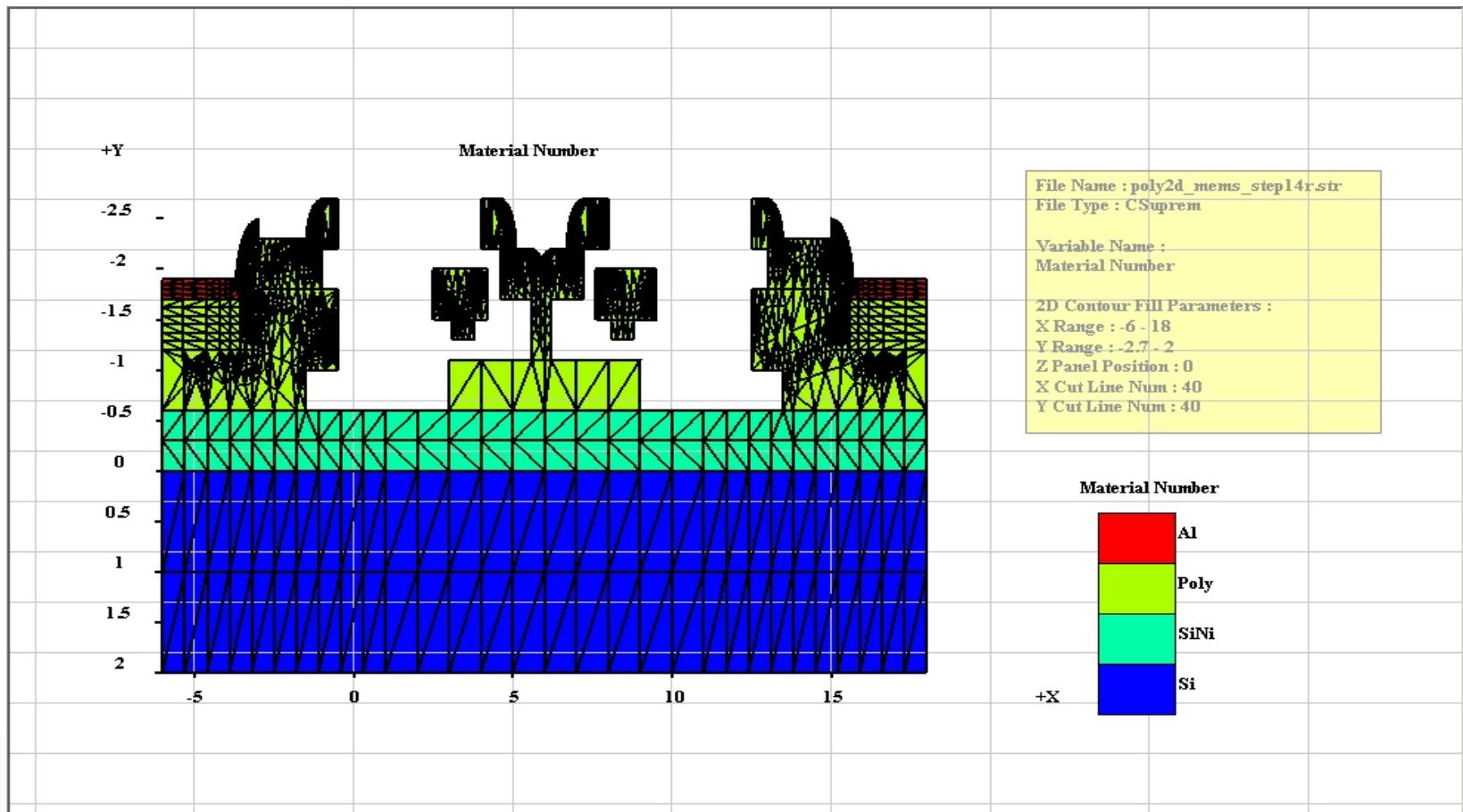
Cross-section before release



Cross-section after release

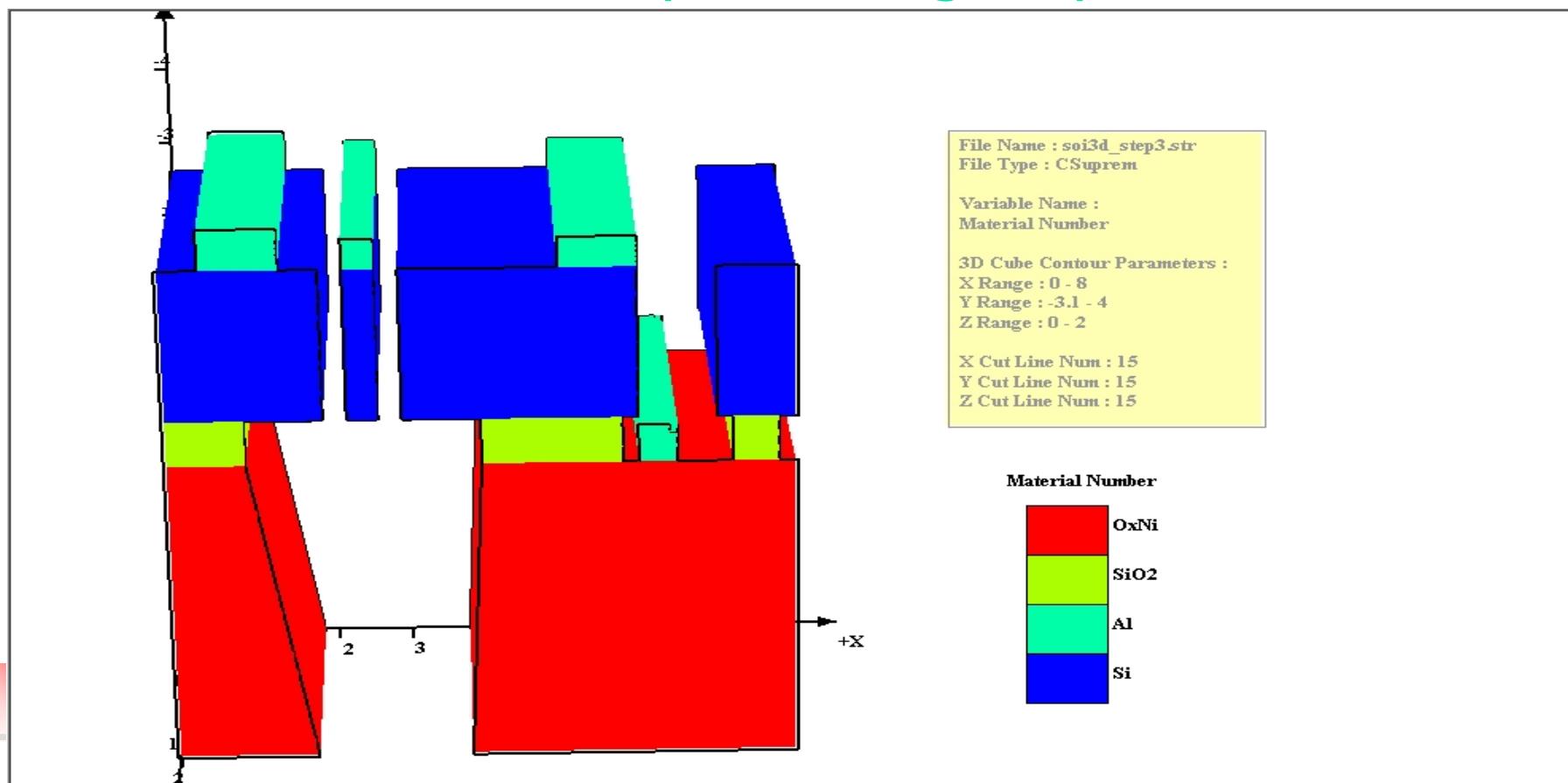


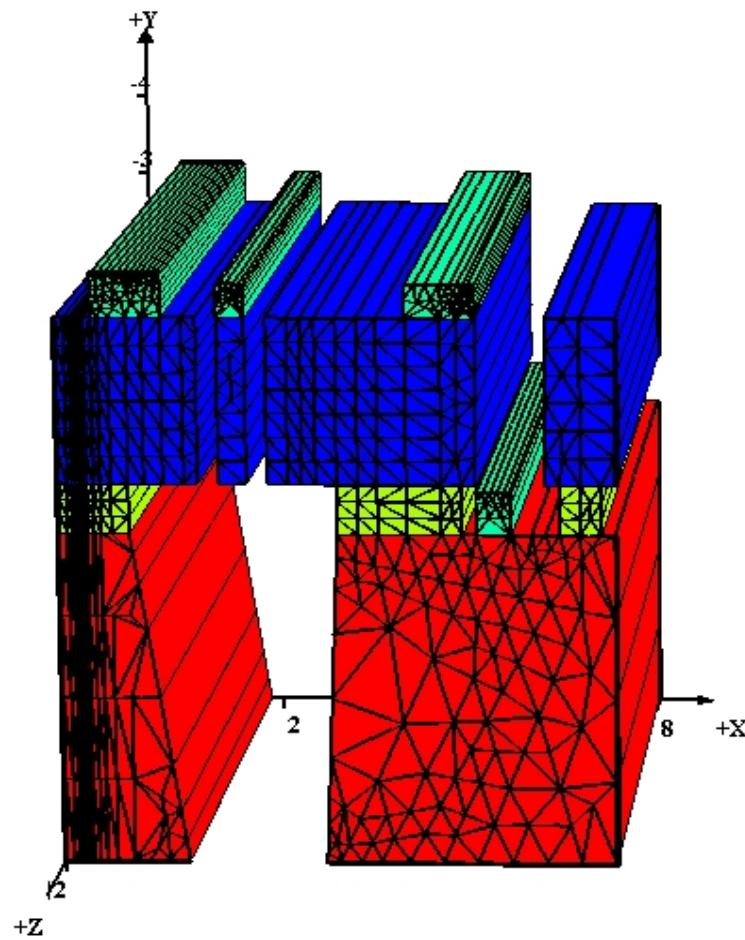
Cross-section's unstructured mesh



IV- SOI MEMS process simulation

Structure at final processing step





File Name : soi3d_step12.str
File Type : CSuprem

Variable Name :
Material Number

3D Cube Contour Parameters :
X Range : 0 - 8
Y Range : -3.1 - 4
Z Range : 0 - 2

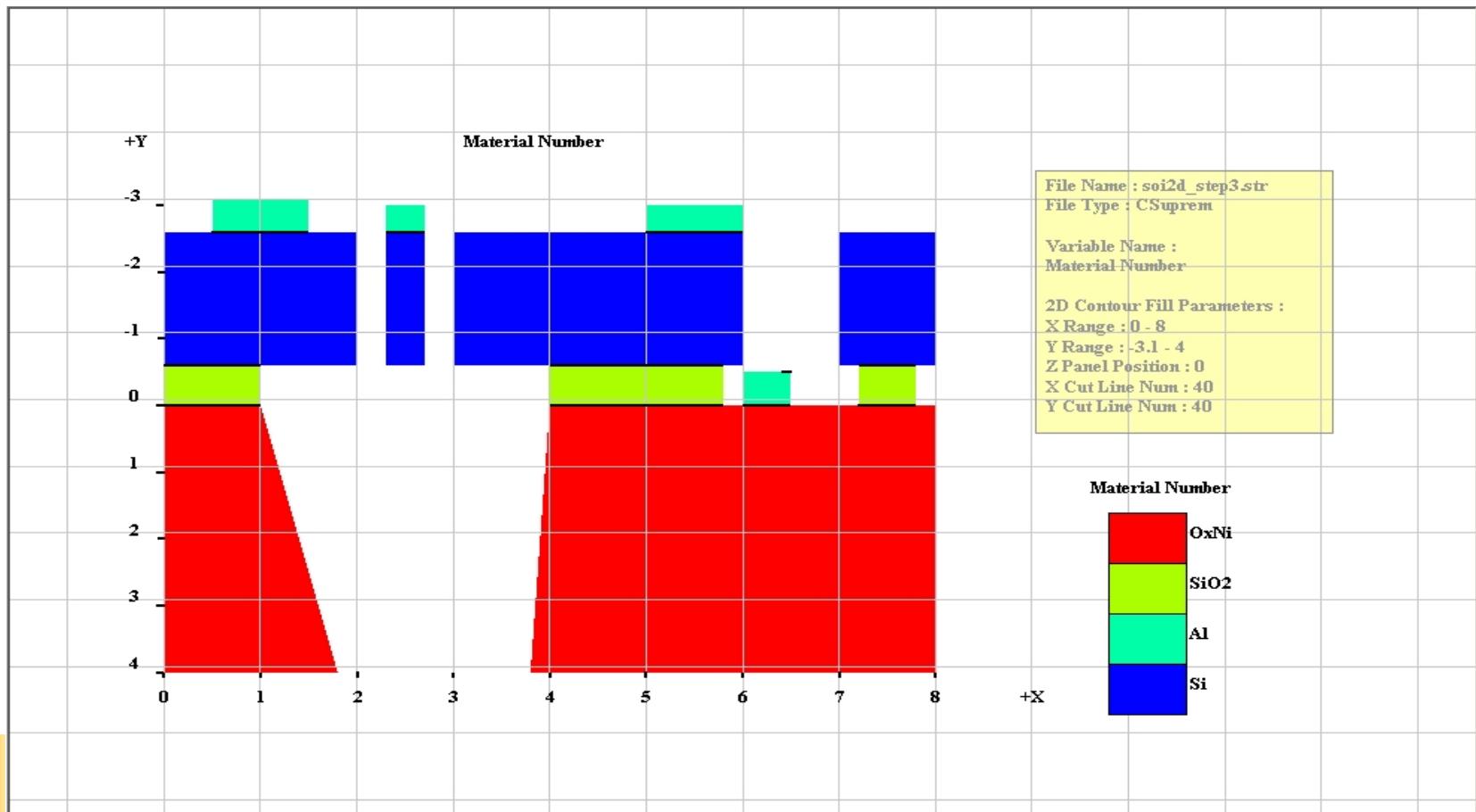
X Cut Line Num : 15
Y Cut Line Num : 15
Z Cut Line Num : 15

Material Number

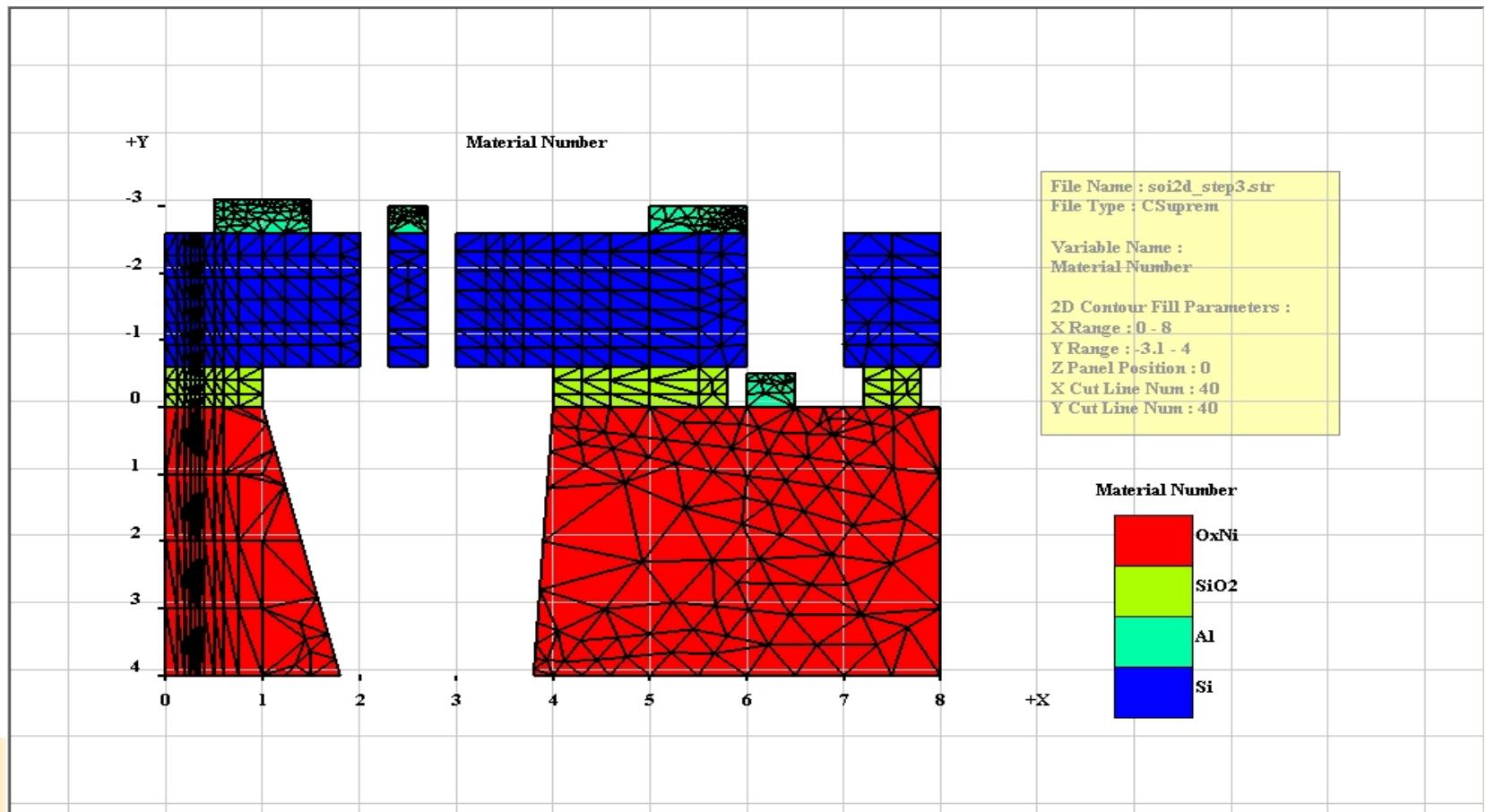


SOI 3D Mesh after release

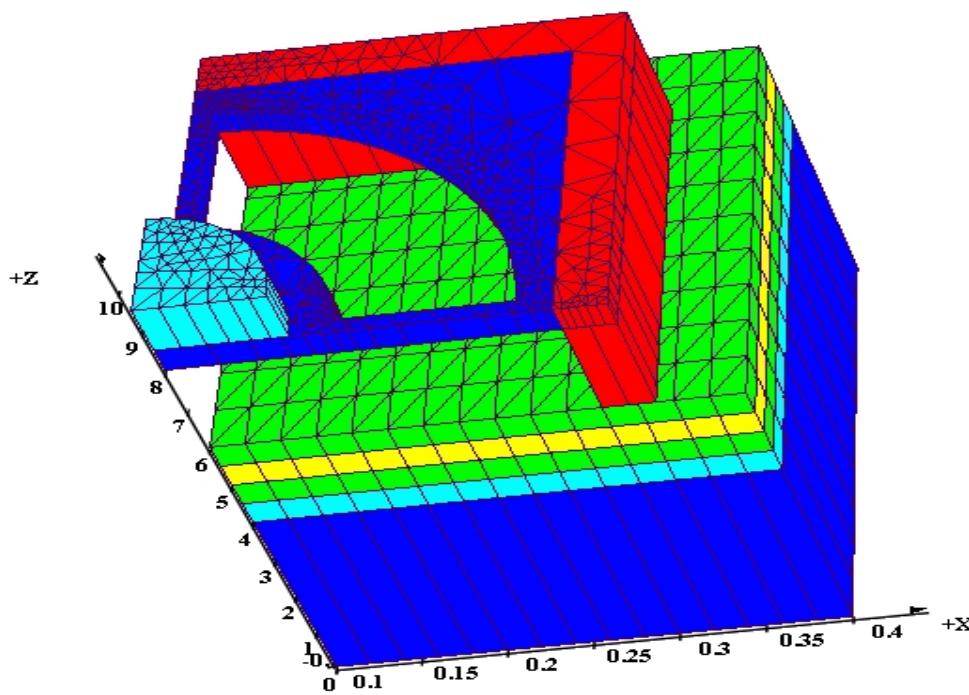
SOI MEMS cross-section



Cross-section's mesh



V- MEMS Tunable VCSOAs process simulation



File Name : 3d_3.str
File Type : CSuprem

Variable Name :
Material Number

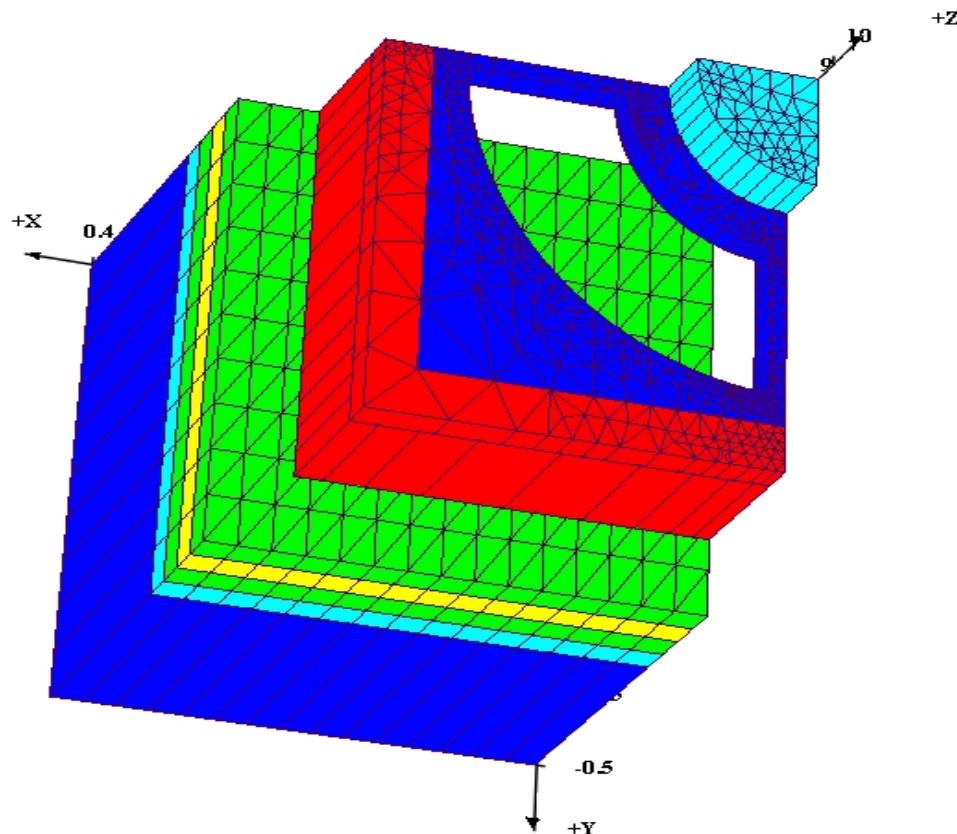
3D Cube Contour Parameters :
X Range : 0.1 - 0.4
Y Range : -0.5 - 0.2
Z Range : 0 - 9.5

X Cut Line Num : 15
Y Cut Line Num : 15
Z Cut Line Num : 15

Material Number

SiO ₂
InGaN
GaN
InGaAsP
GaAs

MT-VCSOA from a different view



File Name : 3d_3.str
File Type : CSuprem

Variable Name :
Material Number

3D Cube Contour Parameters :
X Range : 0.1 - 0.4
Y Range : -0.5 - 0.2
Z Range : 0 - 9.5

X Cut Line Num : 15
Y Cut Line Num : 15
Z Cut Line Num : 15

Material Number

SiO ₂
AlInGaAs
InP
AlGaAs
GaAs

Conclusion

Csuprem is an all-at-once simulator for MEMS:

- It is based on homogenous approach
- It accurately optimizes MEMS manufacturing processes,
- and generates an optimal 3d mesh for simulating MEMS operations